



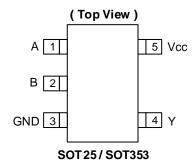
SINGLE 2-INPUT POSITIVE OR GATE

Description

The 74AHCT1G32Q is an automotive compliant single, two-input positive NAND gate with a standard push-pull output. The device is designed for operation with a power supply range of 4.5V to 5.5V. The gate performs the positive Boolean function:

$$Y = A + B$$
 or $Y = \overline{\overline{A} \cdot \overline{B}}$

Pin Assignments



Features

- Grade 1 Ambient Temperature Operation: -40°C to +125°C
- Supply Voltage Range from 4.5V to 5.5V
- ±8mA Output Drive at 5.0V
- CMOS Low-Power Consumption
- Schmitt Trigger Action at All Inputs Make the Circuit Tolerant for Slower Input Rise and Fall Time
- Inputs Not Limited by Vcc
- Balanced Propagation Delays
- Balanced Drive Capability
- ESD Protection Tested per AEC-Q100
- Exceeds 2000-V Human Body Model (AEC-Q100-002)
- Exceeds 1000-V Charged Device Model (AEC-Q100-011)
- Latch-Up Exceeds 100mA (AEC-Q100-004)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The 74AHCT1G32Q is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Applications

- General Purpose Logic
- Wide Array of Products, such as:
 - Automotive Applications within Grade 1 Temperature Range
 - Industrial Computing/Controls/Automation
 - High Reliability Networking/Communications
 - Industrial/Agricultural Equipment

Notes:

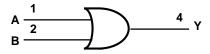
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

| Pin Name | Description |
|----------|----------------|
| Α | Data Input |
| В | Data Input |
| GND | Ground |
| Υ | Data Output |
| Vcc | Supply Voltage |

Logic Diagram



Function Table

| Inp | Output | |
|-----|--------|---|
| Α | В | Υ |
| Н | Х | Н |
| Х | Н | Н |
| L | L | L |

Absolute Maximum Ratings (Notes 4 & 5)

| Symbol | Description | Rating | Unit |
|------------------|------------------------------------------------|-------------------------------|------|
| ESD HBM | Human Body Model ESD Protection | 2 | kV |
| ESD CDM | Charged Device Model ESD Protection | 1 | kV |
| Vcc | Supply Voltage Range | -0.5 to 6.5 | V |
| Vı | Input Voltage Range | -0.5 to 6.5 | V |
| Vo | Voltage Applied to Output in High or Low State | -0.5 to V _{CC} + 0.5 | V |
| lıĸ | Input Clamp Current V _I < 0 | -20 | mA |
| Іок | Output Clamp Current (Vo < 0 or Vo > Vcc) | ±20 | mA |
| lo | Continuous Output Current (Vo = 0 to Vcc) | ±25 | mA |
| Icc | Continuous Current Through V _{CC} | 50 | mA |
| IGND | Continuous Current Through GND | -50 | mA |
| TJ | Operating Junction Temperature | -40 to +150 | °C |
| T _{STG} | Storage Temperature | -65 to +150 | °C |
| PD | Total Power Dissipation (Note 6) | 250 | mW |

Notes:

- 4. Stresses beyond the absolute maximum can result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
- 5. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.
- 6. This will need to be derated at higher operating temperatures to prevent exceeding maximum T_J. Refer to package thermal characteristics section.



Recommended Operating Conditions (Note 7)

| Symbol | Pai | rameter | Min | Max | Unit |
|----------|-----------------------------------------------------------|------------------------|-----|------|------|
| Vcc | Operating Voltage | _ | 4.5 | 5.5 | ٧ |
| V_{IH} | High-Level Input Voltage | $V_{CC} = 5V \pm 0.5V$ | 2.0 | _ | V |
| VIL | Low-Level Input Voltage $V_{CC} = 5V \pm 0.5V$ | | _ | 0.8 | ٧ |
| Vı | Input Voltage | | 0 | 5.5 | V |
| Vo | Output Voltage | | 0 | Vcc | V |
| Іон | High-Level Output Current | $V_{CC} = 5V \pm 0.5V$ | _ | -8 | mA |
| loL | Low-Level Output Current $V_{CC} = 5V \pm 0.5V$ | | _ | 8 | mA |
| Δt/ΔV | Input Transition Rise or Fall Rate $V_{CC} = 5V \pm 0.5V$ | | _ | 20 | ns/V |
| TA | Ambient Temperature — | | -40 | +125 | °C |

Note:

Electrical Characteristics (All typical values are at V_{CC} = 5V, T_A = +25°C.)

| | | T 10 1111 | ., | | +25°C | | -40°C to | o +85°C | -40°C to | +125°C | |
|--------|------------------------------------------|--------------------------------------------------------------------------------------------------------|-----------|------|-------|------|----------|---------|----------|--------|------|
| Symbol | Parameter | Test Conditions | Vcc | Min | Тур | Max | Min | Max | Min | Max | Unit |
| | High Level | V _I = V _{IH} or V _{IL} I _{OH} = -50µA | 4.5V | 4.4 | 4.5 | | 4.4 | ı | 4.4 | l | V |
| Voн | Output Voltage | V _I = V _{IH} or V _{IL} I _{OH} = -8mA | 4.5V | 3.94 | _ | | 3.8 | ı | 3.70 | ı | V |
| ., | V _{OL} Low Level Output Voltage | $V_I = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 50\mu\text{A}$ | 4.5V | ı | 0 | 0.1 | l | 0.1 | - | 0.1 | V |
| VoL | | $V_I = V_{IH} \text{ or } V_{IL}$ $I_{OL} = 8mA$ | 4.5V | 1 | _ | 0.36 | 1 | 0.44 | - | 0.55 | V |
| lı | Input Current | V _I = 5.5V or GND | 0 to 5.5V | _ | _ | ±0.1 | _ | ±1 | _ | ±2 | μΑ |
| Δlcc | Additional Supply Current | Per input pin; V _I = 3.4V; other inputs at V _{CC} or GND; I _O = 0 | 5.5V | _ | _ | 1.35 | _ | 1.5 | _ | 1.5 | mA |
| Icc | Supply Current | V _I = 5.5V or GND Io = 0 | 5.5V | | | 1 | | 10 | _ | 40 | μΑ |
| Сі | Input Capacitance | V _I = V _{CC} or GND | 5.5V | _ | 1.5 | 10 | _ | 10 | _ | 10 | pF |

^{7.} Unused inputs should be held at V_{CC} or Ground.



Package Characteristics

| Symbol | Parameter | Package | Test Conditions | Min | Тур | Max | Unit |
|--------|---------------------|---------|-----------------|-----|-----|-----|------|
| 0 | Thermal Resistance | SOT25 | Note 0 | 1 | 184 | 1 | 9CAM |
| θμα | Junction-to-Ambient | SOT353 | Note 8 | - | 385 | - | °C/W |
| 0 | Thermal Resistance | SOT25 | Nata 0 | _ | 62 | _ | 0000 |
| θυς | Junction-to-Case | SOT353 | Note 8 | - | 164 | - | °C/W |

Note: 8. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

 $Vcc = 5V \pm 0.5V$ (See Figure 1, Typical values at Vcc = 5V.)

| Davameter | From | То | Test | | +25°C | | -40°C to | o +85°C | -40°C to | +125°C | l lmit |
|-----------------|----------------------|----------|-----------------------|-----|-------|-----|----------|---------|----------|--------|--------|
| Parameter | Parameter (Input) (O | (Output) | Conditions | Min | Тур | Max | Min | Max | Min | Max | Unit |
| 4 | A D | , | C _L = 15pF | 1.0 | 3.3 | 6.9 | 1.0 | 8.0 | 1.0 | 9.0 | ns |
| t _{PD} | A or B | Y | C _L = 50pF | 1.0 | 4.8 | 7.9 | 1.0 | 9.0 | 1.0 | 10.0 | ns |

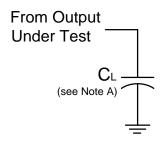
Operating Characteristics

 $T_A = +25$ °C

| Parameter | | Test Conditions | V _{CC} = 5V Typ | Unit |
|-----------------|-------------------------------|---------------------|-----------------------------|------|
| C _{PD} | Power Dissipation Capacitance | f = 1MHz No Load | 10 | pF |



Measurement Information



| Vcc | | Inputs | | CL | |
|---------|------------|--------------------------------|------|-------|------|
| 100 | Vı | t _R /t _F | VM | Vm | 91 |
| 5V±0.5V | GND to Vcc | ≤3ns | 1.5V | Vcc/2 | 15pF |
| 5V±0.5V | GND to Vcc | ≤3ns | 1.5V | Vcc/2 | 50pF |

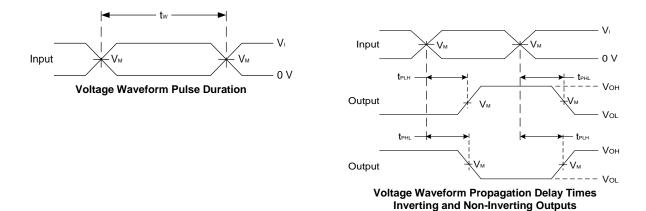


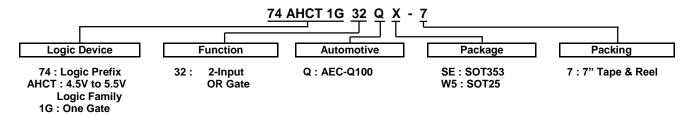
Figure 1. Load Circuit and Voltage Waveforms

Notes:

- A. Includes test lead and test apparatus capacitance. B. All pulses are supplied at pulse repetition rate \leq 1MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as t_{PD}.



Ordering Information (Note 9)



| Part Number | Package | Package | Package Size | 7" Tape | and Reel |
|-----------------|---------|-----------------|-------------------------------------------------------------------|------------------|--------------------|
| Fait Number | Code | (Notes 10 & 11) | Fackage Size | Quantity | Part Number Suffix |
| 74AHCT1G32QSE-7 | SE | SOT353 | 2.15mm × 2.1mm × 1.1mm 0.65mm lead pitch | 3000/Tape & Reel | -7 |
| 74AHCT1G32QW5-7 | W5 | SOT25 | 3.0 mm \times 2.8 mm \times 1.2 mm 0.95 mm lead pitch | 3000/Tape & Reel | -7 |

Notes: 9. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

10. Pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.

11. The taping orientation is located on our website at https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.

Marking Information

(Top View)

5 4 XXX YWX 1 2 3

XXX: Identification Code

<u>Y</u> : Year 0~9

: Week: A~Z 1~26 week a~z 27~52 week

z represents week 52 and 53

X : A~ Z: Internal Code

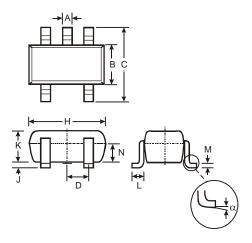
SOT 25 / SOT 353

| Part Number | Package | Identification Code |
|-----------------|---------|---------------------|
| 74AHCT1G32QW5-7 | SOT25 | ZWQ |
| 74AHCT1G32QSE-7 | SOT353 | ZWQ |



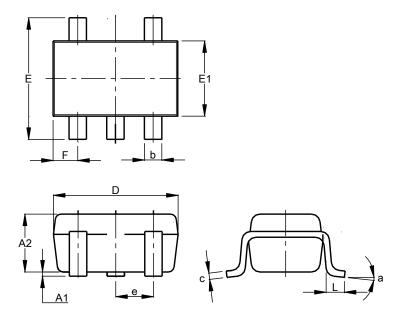
Package Outline Dimensions

(1) Package Type: SOT25



| | SOT | SOT25 | | | | | | | | |
|-------|--------|--------|------|--|--|--|--|--|--|--|
| Dim | Min | Max | Тур | | | | | | | |
| Α | 0.35 | 0.50 | 0.38 | | | | | | | |
| В | 1.50 | 1.70 | 1.60 | | | | | | | |
| С | 2.70 | 3.00 | 2.80 | | | | | | | |
| D | | - | 0.95 | | | | | | | |
| Н | 2.90 | 3.10 | 3.00 | | | | | | | |
| J | 0.013 | 0.10 | 0.05 | | | | | | | |
| K | 1.00 | 1.30 | 1.10 | | | | | | | |
| L | 0.35 | 0.55 | 0.40 | | | | | | | |
| M | 0.10 | 0.20 | 0.15 | | | | | | | |
| Ν | 0.70 | 0.80 | 0.75 | | | | | | | |
| α | 0° | 8° | - | | | | | | | |
| All D | imensi | ons in | mm | | | | | | | |

(2) Package Type: SOT353



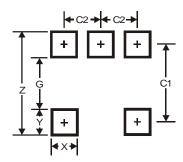
| SOT353 | | | | |
|----------------------|-----------|------|-------|--|
| Dim | Min | Max | Тур | |
| A 1 | 0.00 | 0.10 | 0.05 | |
| A2 | 0.90 | 1.00 | 0.95 | |
| b | 0.10 | 0.30 | 0.25 | |
| С | 0.10 | 0.22 | 0.11 | |
| D | 1.80 | 2.20 | 2.15 | |
| Е | 2.00 | 2.20 | 2.10 | |
| E1 | 1.15 | 1.35 | 1.30 | |
| е | 0.650 BSC | | | |
| F | 0.40 | 0.45 | 0.425 | |
| L | 0.25 | 0.40 | 0.30 | |
| а | 0° | 8° | | |
| All Dimensions in mm | | | | |



Suggested Pad Layout

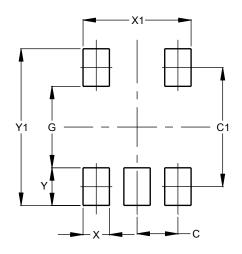
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT25



| Dimensions | Value |
|------------|-------|
| Z | 3.20 |
| G | 1.60 |
| Х | 0.55 |
| Υ | 0.80 |
| C1 | 2.40 |
| C2 | 0.95 |

(2) Package Type: SOT353



| Dimensions | Value (in mm) |
|------------|------------------|
| С | 0.650 |
| C1 | 1.900 |
| G | 1.300 |
| Х | 0.420 |
| X1 | 1.720 |
| Υ | 0.600 |
| Y1 | 2.500 |

Mechanical Data

SOT25

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208@3
- Weight: 0.0158 grams (Approximate)

SOT353

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0064 grams (Approximate)



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